## Silicon P-Channel MOS FET

# HITACHI

ADE-208-1195 (Z) 1st. Edition Mar. 2001

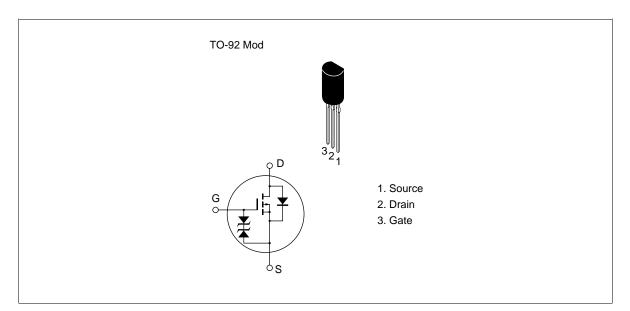
### Application

High speed power switching

#### Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device can be driven from 5 V source
- Suitable for Switching regulator, DC DC converter

#### Outline





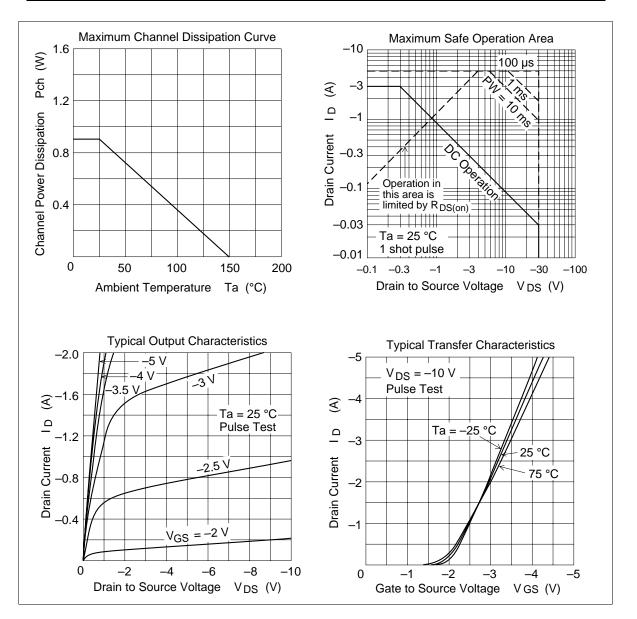
## **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

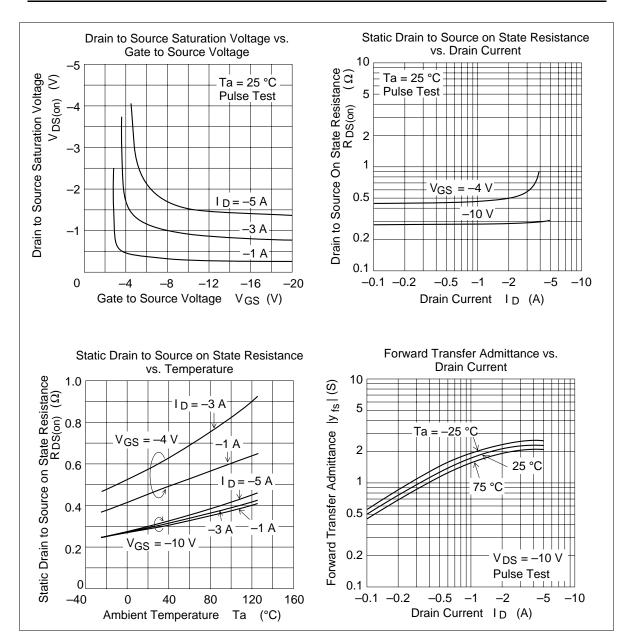
Item	Symbol	Ratings	Unit	
Drain to source voltage	V <sub>DSS</sub>	-30	V	
Gate to source voltage	V <sub>GSS</sub>	±20	V	
Drain current	I <sub>D</sub>	-3	А	
Drain peak current	L <sub>D(pulse)</sub> *1	-5	А	
Body to drain diode reverse drain current	I <sub>DR</sub>	-3	A	
Channel dissipation	Pch	0.9	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

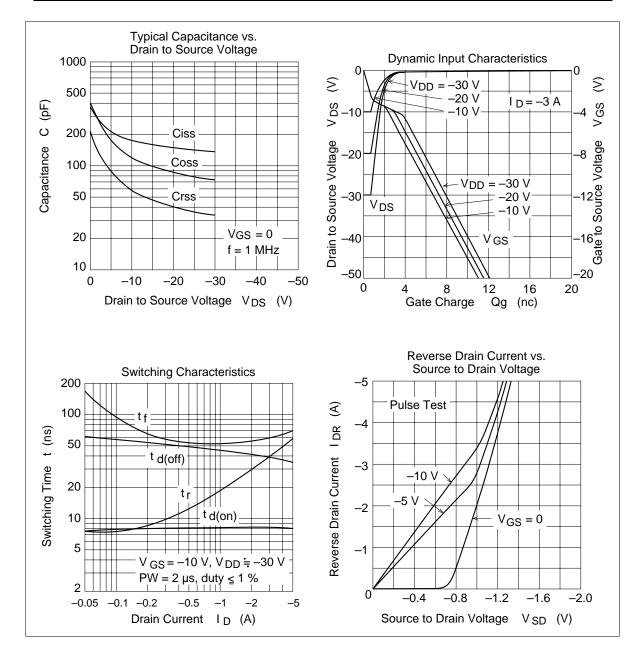
Note: 1. PW 10 µs, duty cycle 1 %

## **Electrical Characteristics** (Ta = 25°C)

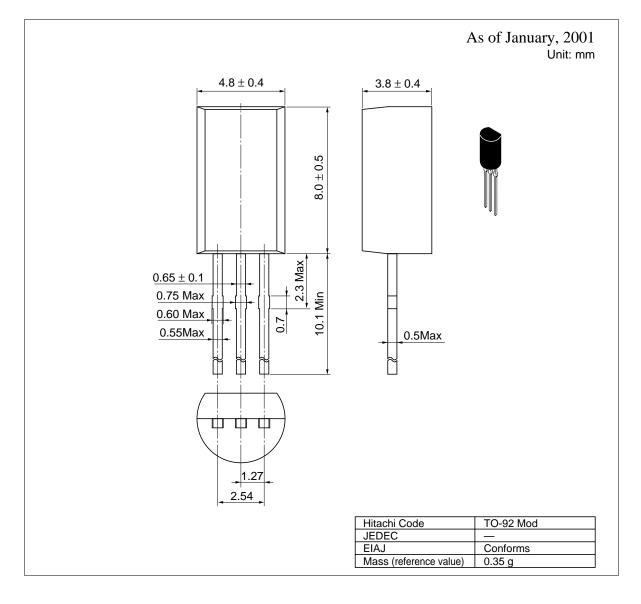
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	-30	_	_	V	$I_{\rm D} = -10$ mA, $V_{\rm GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	—	—	±10	μA	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	—	—	-10	μA	$V_{\rm DS} = -24$ V, $V_{\rm GS} = 0$
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	-1.0	—	-2.5	V	$I_{\rm D} = -1 \text{ mA}, V_{\rm DS} = -10 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.3	0.4		$I_{D} = -2 A$ $V_{GS} = -10 V^{*1}$
		—	0.55	0.8		$I_{D} = -2 A$ $V_{GS} = -4 V^{*1}$
Forward transfer admittance	y <sub>fs</sub>	1.0	1.7	_	S	$I_{D} = -1 A$ $V_{DS} = -10 V^{*1}$
Input capacitance	Ciss	—	177	—	pF	V <sub>DS</sub> = -10 V
Output capacitance	Coss	—	120		pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	59		pF	f = 1 MHz
Turn-on delay time	t <sub>d(on)</sub>	_	8		ns	$I_{\rm D} = -2$ A
Rise time	t,	_	28		ns	V <sub>GS</sub> = -10 V
Turn-off delay time	$t_{d(off)}$		45	_	ns	R <sub>L</sub> = 15
Fall time	t <sub>f</sub>	_	60	—	ns	







### **Package Dimensions**



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#### Hitachi, Ltd.

Semiconductor & Integrated Circuits. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL	NorthAmerica Europe	: http://semiconductor.hitachi.com/ : http://www.hitachi-eu.com/hel/ecg
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#### For further information write to:

Hitachi Semiconductor
(America) Inc.
179 East Tasman Drive,
San Jose,CA 95134
Tel: <1> (408) 433-1990
Fax: <1>(408) 433-0223

Hitachi Europe GmbH Electronic Components Group Dornacher Straße 3 D-85622 Feldkirchen, Munich Germany Tel: <49> (89) 9 9180-0 Fax: <49> (89) 9 29 30 00 Hitachi Europe Ltd.

Electronic Components Group. Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA, United Kingdom Tel : <886>-(2)-2718-3666 Tel: <44> (1628) 585000 Fax: <44> (1628) 585160

Hitachi Asia Ltd. Hitachi Tower 16 Collyer Quay #20-00, Singapore 049318 Tel : <65>-538-6533/538-8577 Fax : <65>-538-6933/538-3877 URL : http://www.hitachi.com.sg

Hitachi Asia Ltd (Taipei Branch Office) 4/F, No. 167, Tun Hwa North Road, Hung-Kuo Building. Taipei (105), Taiwan Fax : <886>-(2)-2718-8180 Telex : 23222 HAS-TP URL : http://www.hitachi.com.tw

Hitachi Asia (Hong Kong) Ltd. Group III (Electronic Components) 7/F., North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon, Hong Kong Tel: <852>-(2)-735-9218 Fax : <852>-(2)-730-0281 URL : http://www.hitachi.com.hk

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